



US00D398924S

**United States Patent** [19]  
**Shindo**

[11] **Patent Number: Des. 398,924**

[45] **Date of Patent: \*\*Sep. 29, 1998**

[54] **WIRELESS TELEPHONE**

*Attorney, Agent, or Firm—Foley & Lardner*

[75] Inventor: **Koji Shindo**, Tokyo, Japan

[57] **CLAIM**

[73] Assignee: **Sony Corporation**, Tokyo, Japan

The ornamental design for a wireless telephone, as shown and described.

[\*\*] Term: **14 Years**

**DESCRIPTION**

[21] Appl. No.: **72,781**

FIG. 1 is a perspective view of a first embodiment of a wireless telephone showing our new design;

[22] Filed: **Jun. 30, 1997**

FIG. 2 is a top plan view thereof;

[51] **LOC (6) Cl. .... 14-03**

FIG. 3 is a left side elevational view thereof;

[52] **U.S. Cl. .... D14/138; D14/147**

FIG. 4 is a front elevational view thereof;

[58] **Field of Search .... D14/137, 138, D14/147-148, 247-248, 250, 140-142, 114; 379/368, 419, 420, 428, 440, 433, 434; 455/550, 575, 90, 556, 558**

FIG. 5 is a right side elevational view thereof;

FIG. 6 is a rear elevational view thereof;

[56] **References Cited**

FIG. 7 is a bottom plan view thereof;

**U.S. PATENT DOCUMENTS**

FIG. 8 is a perspective view of a second embodiment of a wireless telephone showing our new design;

D. 332,785	1/1993	Nagele et al. ....	D14/138
D. 347,005	5/1994	Suzuki .....	D14/138
D. 353,808	12/1994	Taniguchi et al. ....	D14/138
D. 358,148	5/1995	Nagele et al. ....	D14/147 X
D. 359,284	6/1995	Hung .....	D14/148 X
D. 366,872	2/1996	Nagele et al. ....	D14/138
D. 368,712	4/1996	Wicks et al. ....	D14/147
D. 374,666	10/1996	Matsumoto .....	D14/147
D. 380,750	7/1997	Sato et al. ....	D14/147 X
D. 382,871	8/1997	Nagai et al. ....	D14/138
D. 385,558	10/1997	Liu .....	D14/148
D. 388,432	12/1997	Lytle .....	D14/147 X

FIG. 9 is a top plan view of the embodiment of FIG. 8;

FIG. 10 is a left side elevational view of the embodiment of FIG. 8;

FIG. 11 is a front elevational view of the embodiment of FIG. 8;

FIG. 12 is a right side elevational view of the embodiment of FIG. 8;

FIG. 13 is a rear elevational view of the embodiment of FIG. 8; and,

FIG. 14 is a bottom plan view of the embodiment of FIG. 8.

**OTHER PUBLICATIONS**

“Sony style”, pp. 173, 174 and 176, Sony Corp. (Fall/Winter 1996).

*Primary Examiner—Jeffrey Asch*

**1 Claim, 6 Drawing Sheets**

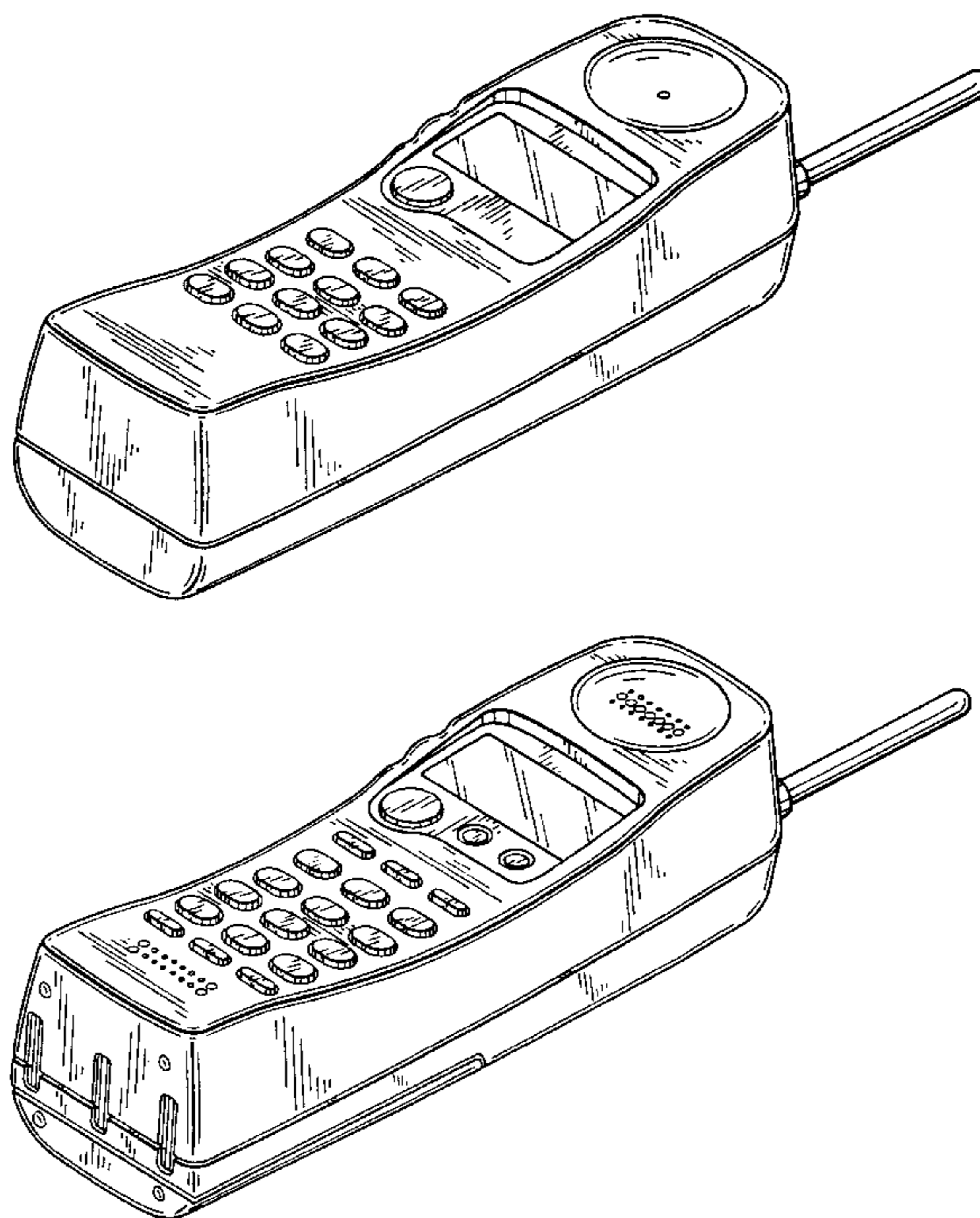
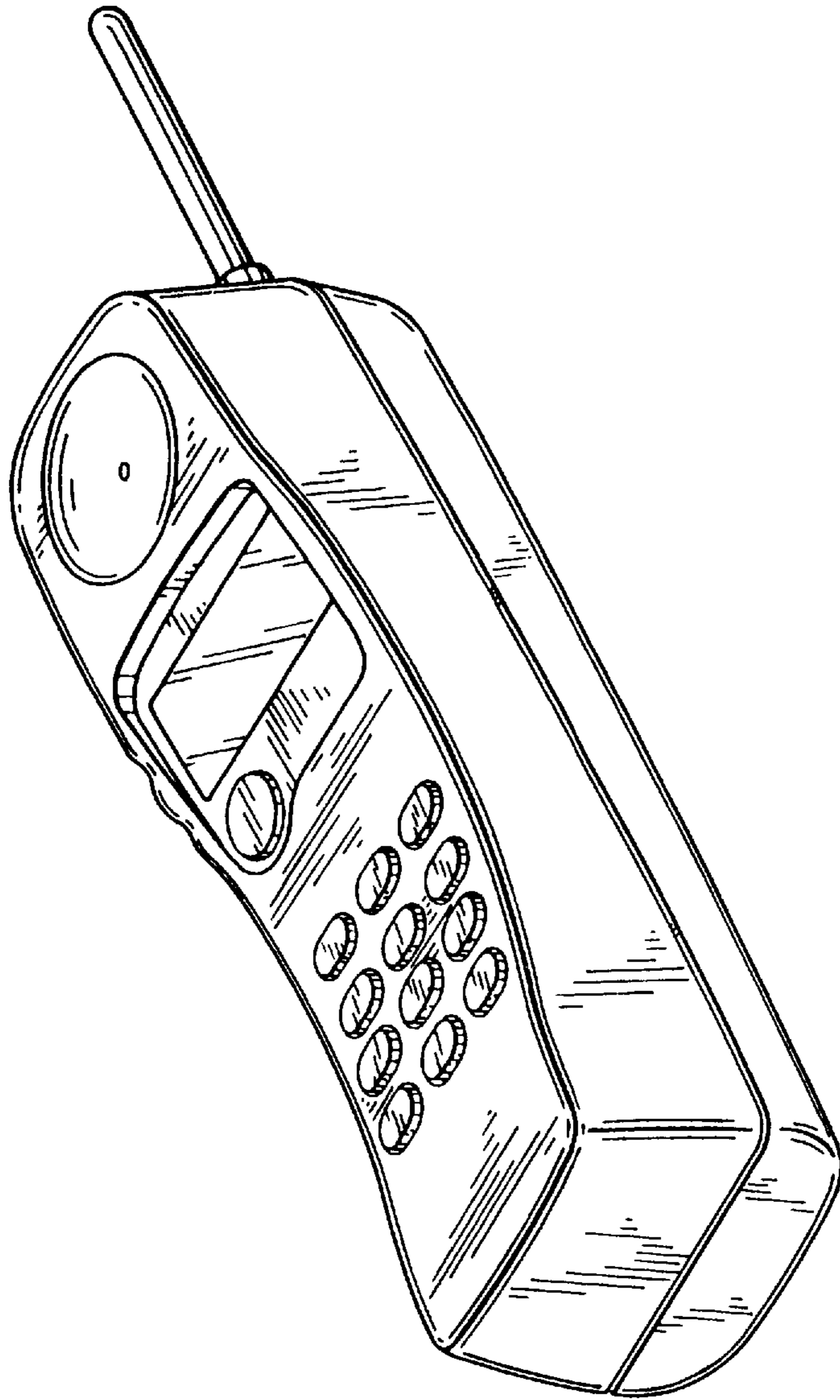


FIG. 1



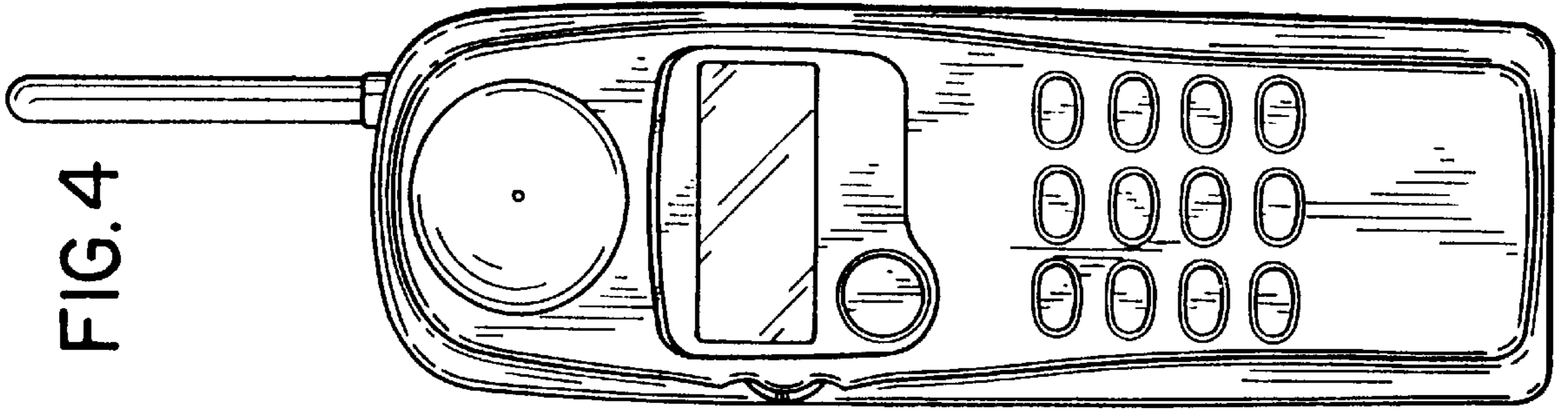


FIG. 4

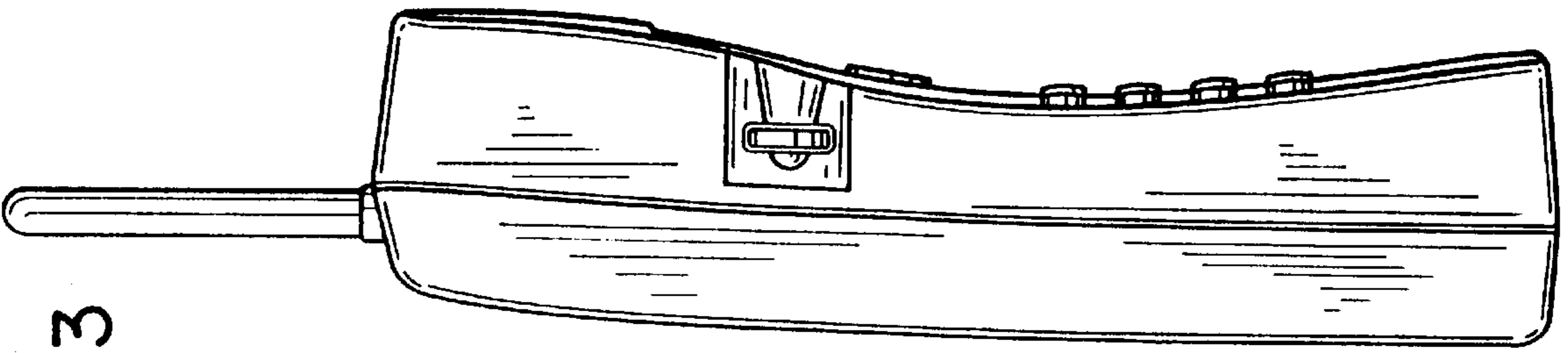


FIG. 3

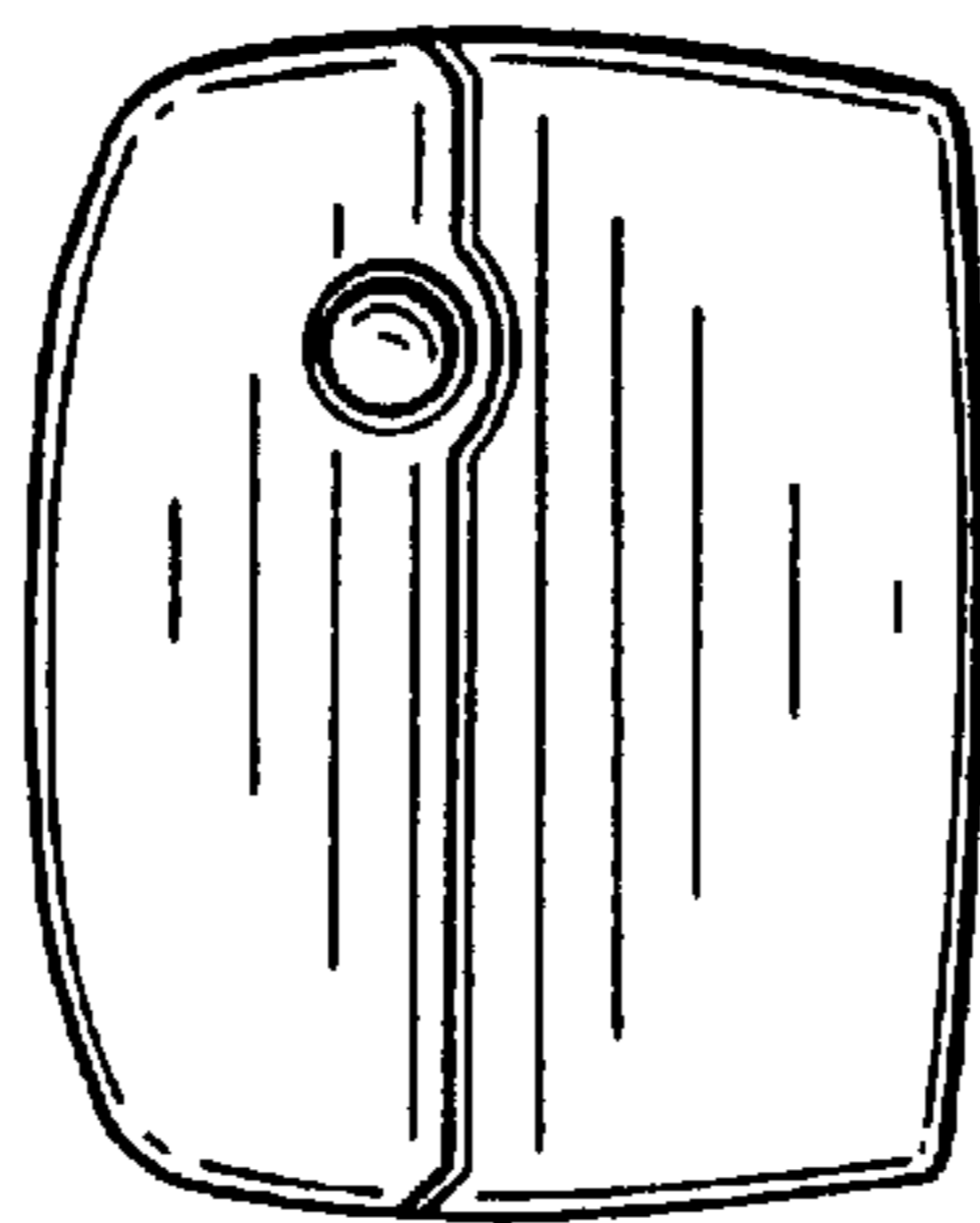


FIG. 2

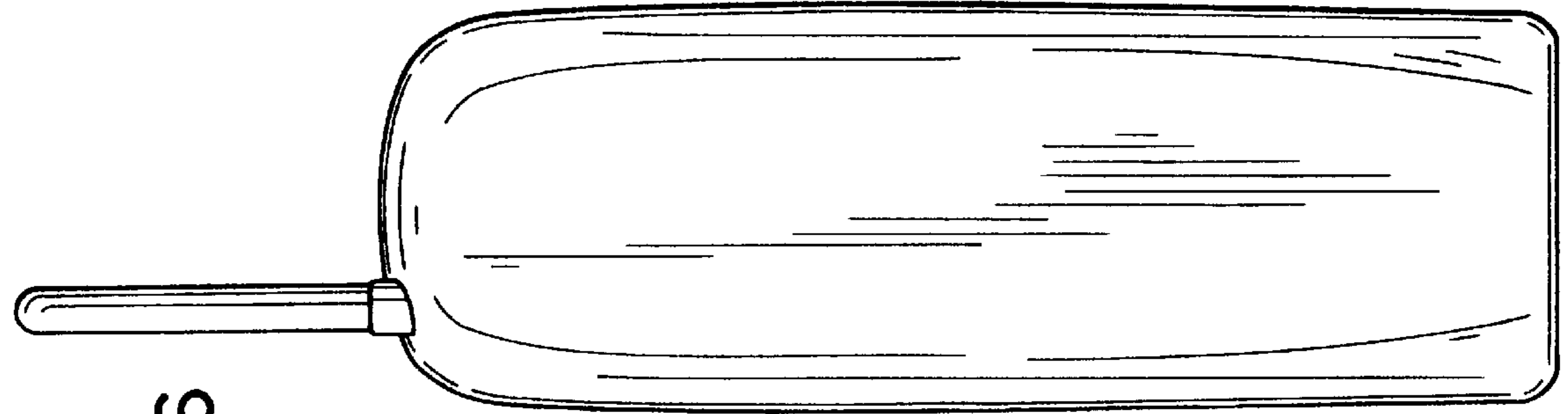


FIG. 6

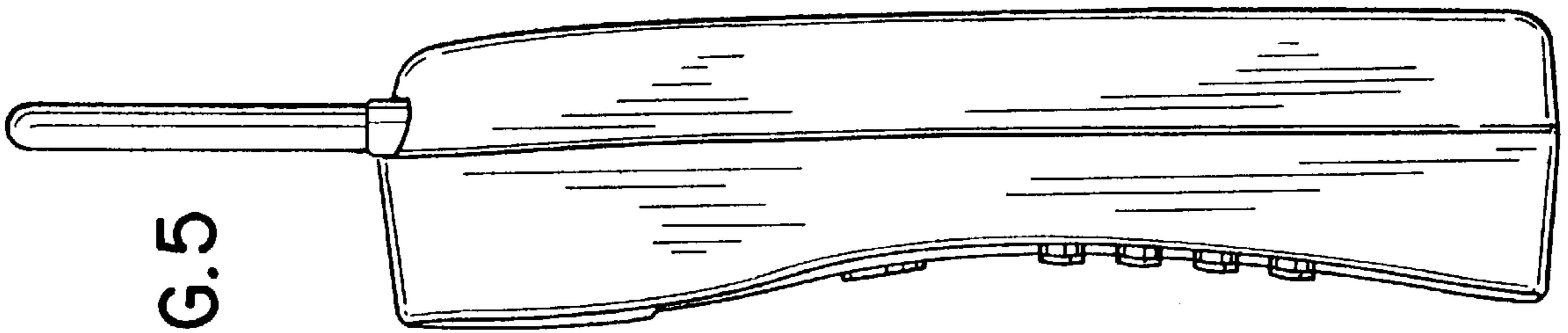


FIG. 5

FIG. 7

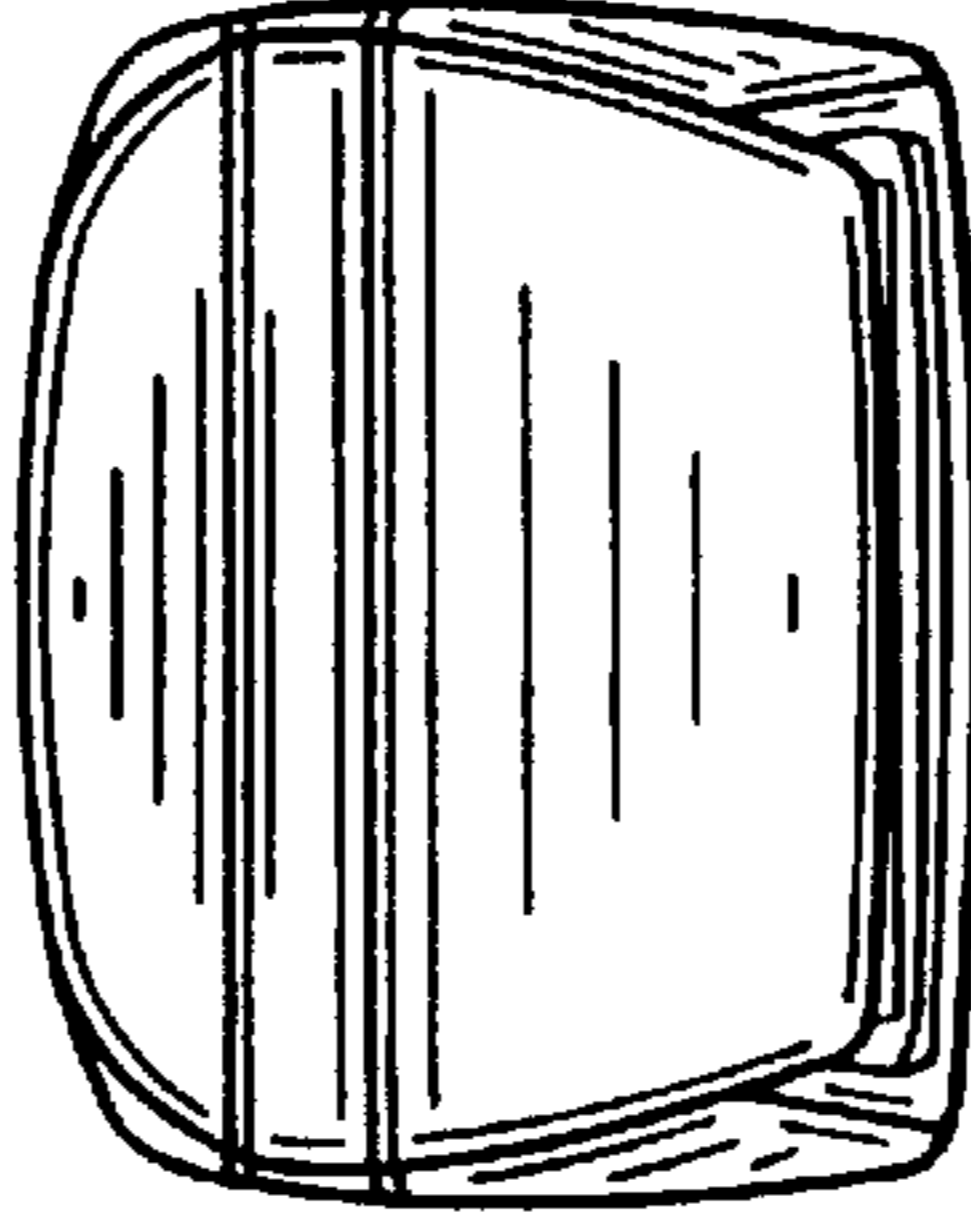
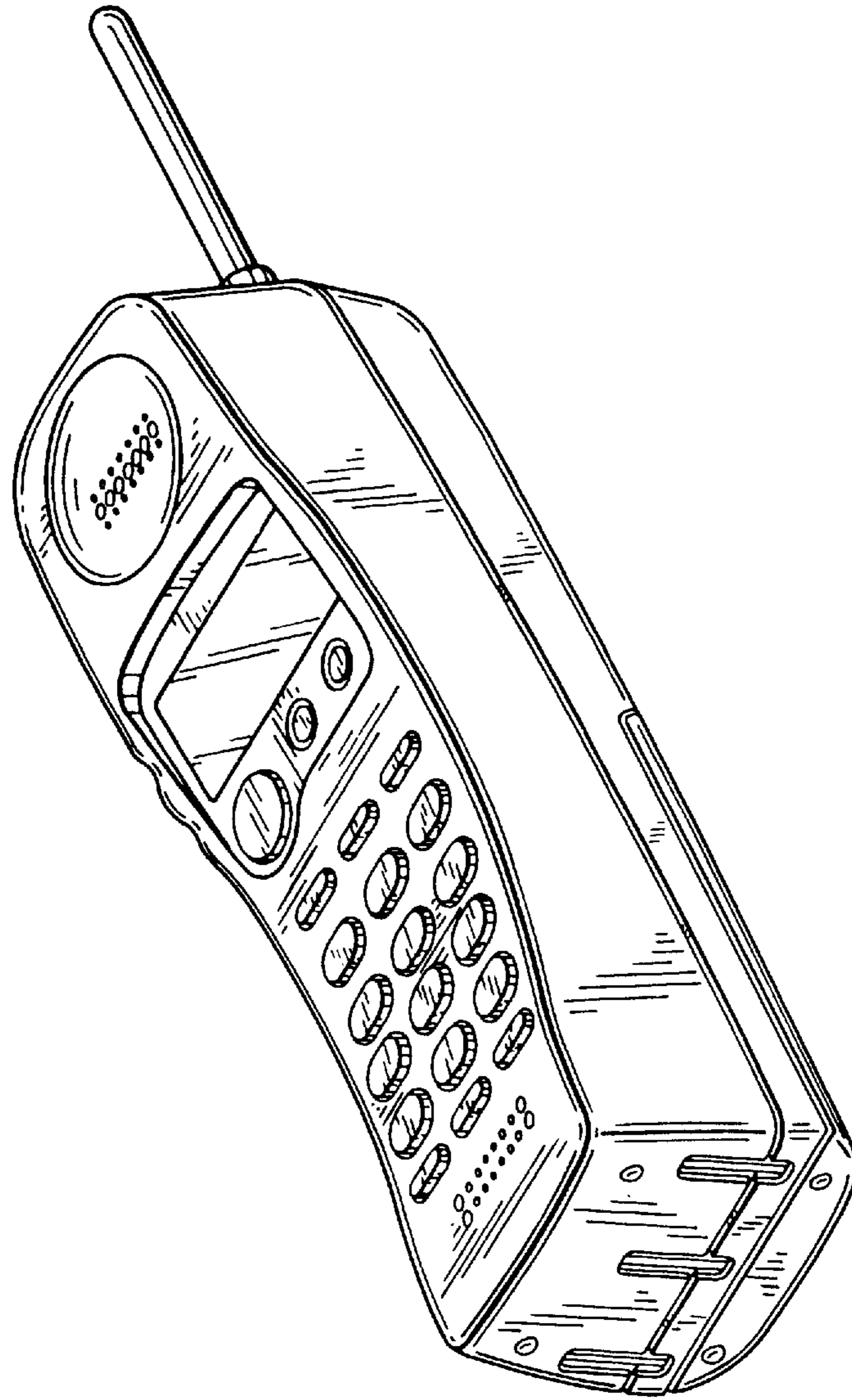


FIG. 8



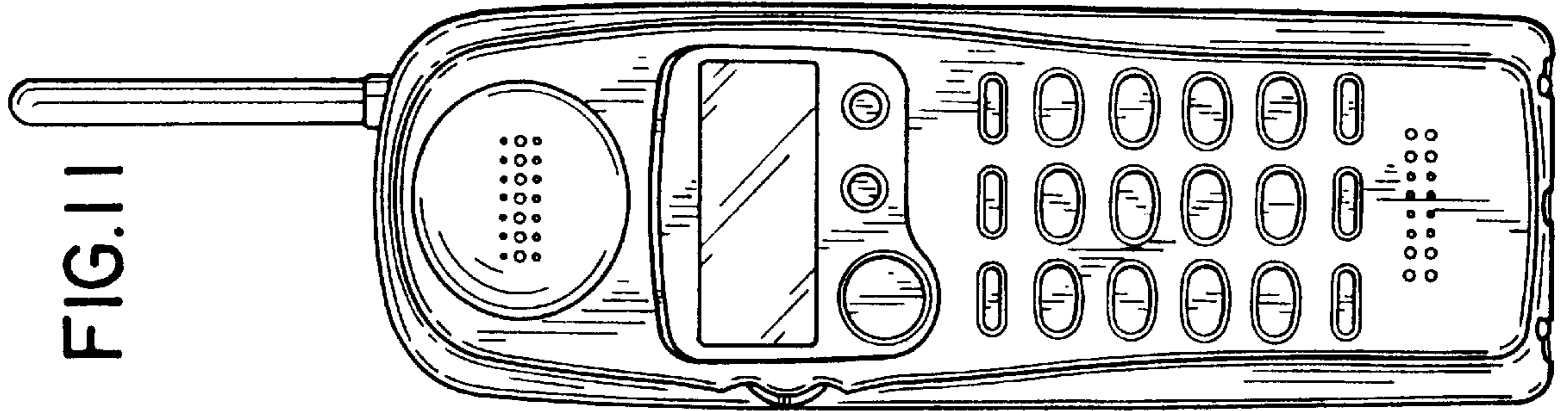


FIG. 11

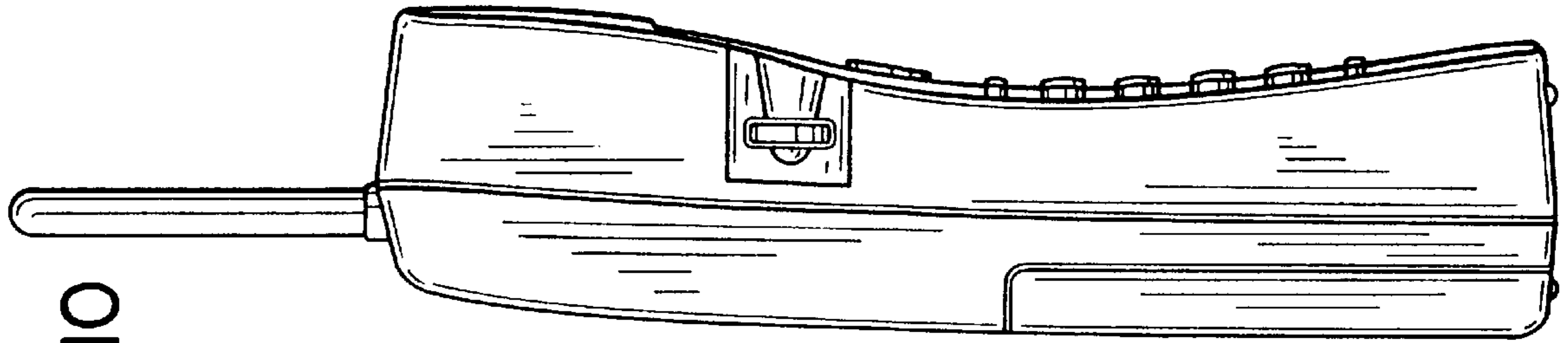


FIG. 10

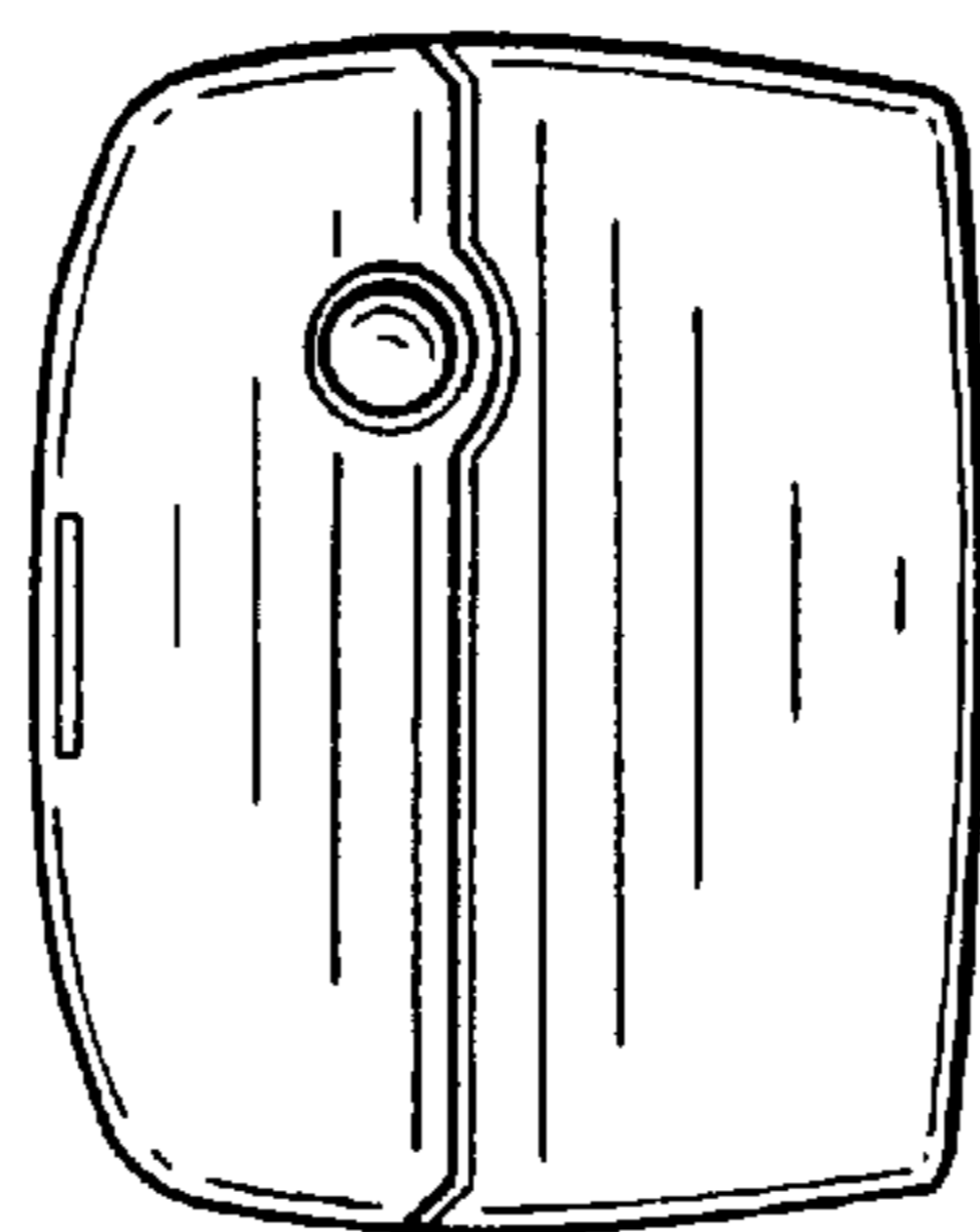


FIG. 9

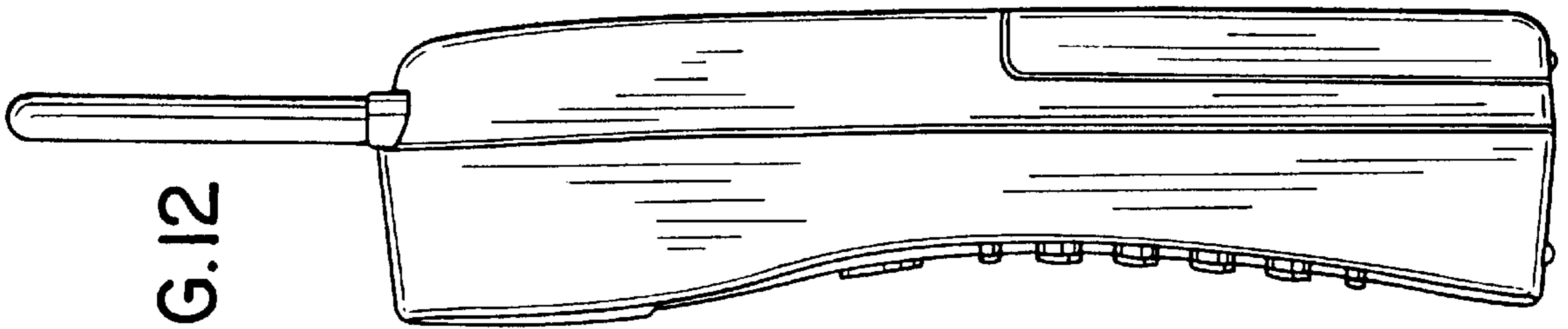


FIG. 12

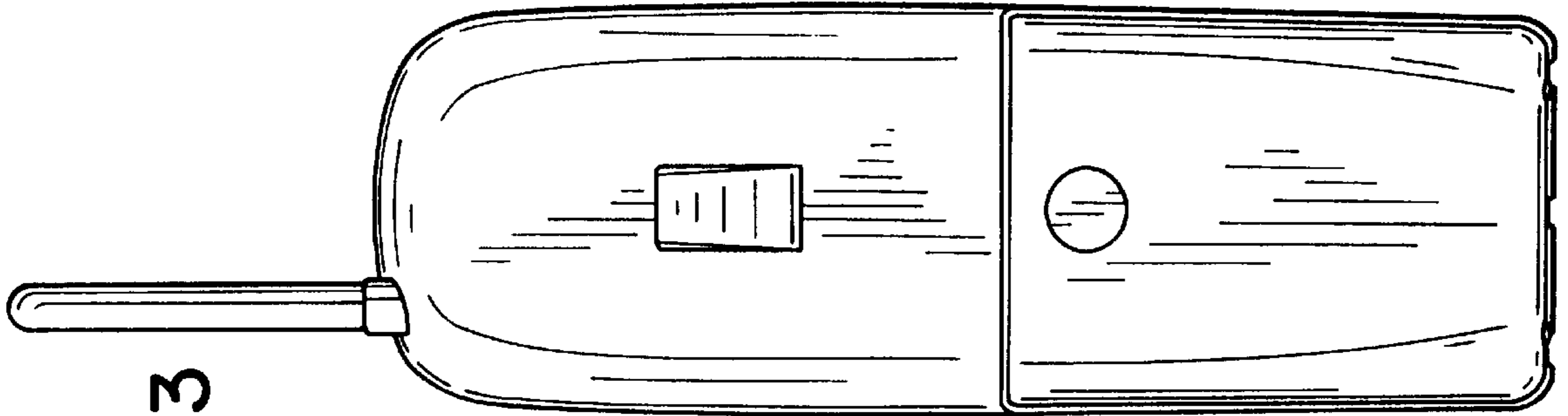


FIG. 13

FIG. 14

